Components marked 'DNP' should not be populated.

Assembly variant: [No Variations]
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE | BOARD #: PMP20808 | REV: A | SUN REV: Not In VersionControl
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| | | | IGNORE ->

PLOT NAME = Bottom Assembly Drawing | GENERATED: 11/30/2017 6:38:56 PM | TEXAS INSTRUMENTS
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